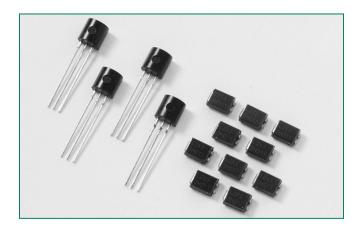


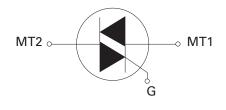
#### RoHS LxX8Ex & LxXx & QxX8E & QxXx Series



#### **Main Features**

Symbol	Value	Unit
I <sub>T(RMS)</sub>	0.8	А
V <sub>DRM</sub> /V <sub>RRM</sub>	400 to 600	V
I <sub>GT (Q1)</sub>	3 to 25	mA

#### **Schematic Symbol**



#### **Description**

0.8 Amp bi-directional solid state switch series is designed for AC switching and phase control applications such as motor speed and temperature modulation controls, lighting controls, and static switching relays.

**Sensitive** type devices guarantee gate control in Quadrants I & IV needed for digital control circuitry.

**Standard** type devices normally operate in Quadrants I & III triggered from AC line.

#### **Features**

- RoHS Compliant
- Glass passivated junctions
- Voltage capability up to 600 V
- Surge capability up to 10 A

#### **Applications**

Excellent for lower current heating controls, water valves, and solenoids.

Typical applications are AC solid-state switches, home/brown goods and white goods appliances.

Sensitive gate Triacs can be directly driven by microprocessor or popular opto-couplers/isolators.

#### Absolute Maximum Ratings — Sensitive Triacs (4 Quadrants)

Symbol	Paramete	Parameter				
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave)	LxX8y/LxXy	$T_{\rm C} = 50^{\circ}{\rm C}$	0.8	А	
	Non repetitive surge peak on-state current	f = 50 Hz	t = 20 ms	8.3	A	
TSM	(full cycle, T <sub>J</sub> initial = 25°C)	f = 60 Hz	t = 16.7 ms	10	A	
l²t	I²t Value for fusing	$t_{p} = 8.3$	3 ms	0.41	A <sup>2</sup> s	
di/dt	Critical rate of rise of on-state current ( $I_G = 50$ mA with $\leq 0.1 \mu$ s rise time)	f = 120 Hz	T <sub>J</sub> = 110°C	20	A/µs	
I <sub>GTM</sub>	Peak gate trigger current	t <sub>p</sub> = 10 μs	T <sub>J</sub> = 110°C	1	А	
P <sub>G(AV)</sub>	Average gate power dissipation		T <sub>J</sub> = 110°C	0.2	W	
	Ctorage temporature renge		LxX8Ey	-65 to 150	°C	
$T_{stg}$	Storage temperature range		LxXy	-40 to 150		
			LxX8Ey	-65 to 110	90	
$T_{J}$	Operating junction temperature range		LxXy	-40 to 110	°C	

Note: x = voltage, y = sensitivity

### Teccor® brand Thyristors 0.8 Amp Sensitive & Standard Triacs



#### **Absolute Maximum Ratings — Standard Triac**

Symbol	Paramete	Parameter				
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave)	QxXE8y/ QxXy	T <sub>c</sub> = 60°C	0.8	А	
	Non repetitive surge peak on-state current	f = 50 Hz	t = 20 ms	8.3	A	
TSM	(full cycle, $T_J$ initial = 25°C) $f = 60 \text{ Hz}$	t = 16.7 ms	10	A		
l²t	I²t Value for fusing	$t_{p} = 8.3$	3 ms	0.41	A <sup>2</sup> s	
di/dt	Critical rate of rise of on-state current ( $I_G = 200 \text{mA}$ with $\leq 0.1 \mu \text{s}$ rise time)	f = 120 Hz	T <sub>J</sub> = 125°C	20	A/µs	
I <sub>GTM</sub>	Peak gate trigger current $ \begin{array}{c} t_{_{D}} = 10~\mu s; \\ I_{_{GT}} \leq I_{_{GTM}} \end{array} $		T <sub>J</sub> = 125°C	1	А	
$P_{G(AV)}$	Average gate power dissipation		T <sub>J</sub> = 125°C	0.2	W	
т	Storage junction temperature range		L/QxX8Ey	-65 to 150	°C	
T <sub>stg</sub>			L/QxXy	-40 to 150		
Т	Operating junction temperature range		L/QxX8Ey	-65 to 125	°C	
l <sub>J</sub>	Operating junction temperature range		L/QxXy	-40 to 125		

Note: x = voltage, y = sensitivity

#### Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise specified) — Sensitive Triac (4 Quadrants)

Symbol	Test Conditions	Quad	lrant	LxX8E3 LxX3	LxX8E5 LxX5	LxX8E6 LxX6	LxX8E8 LxX8	Unit		
		1 – 11 – 111	MAX.	3	5	5	10	A		
I <sub>GT</sub>	$V_D = 12V R_L = 30 \Omega$	$V_D = 12V R_L = 30 \Omega$	$V_D = 12V R_L = 30 \Omega$	IV	IVIAA.	3	5	10	20	mA
$V_{\rm GT}$		ALL	MAX.		1	.3		V		
$V_{GD}$	$V_D = V_{DRM} R_L = 3.3 \text{ k}\Omega T_J = 110^{\circ}\text{C}$	ALL	MIN.	0.2				V		
I <sub>H</sub>	I <sub>T</sub> = 100mA		MAX.	5	10	10	15	mA		
dv/dt	V V Coto Open T 100°C	400V	TYP.	15	15	25	30	V/µs		
uv/ut	$V_D = V_{DRM}$ Gate Open $T_J = 100$ °C	600V	1117.	10	10	20	25	ν/μ5		
(dv/dt)c	$(di/dt)c = 0.43 \text{ A/ms } T_J = 110^{\circ}\text{C}$		TYP.	0.5	1	1	2	V/µs		
t <sub>gt</sub>	$I_{G} = 2 \times I_{GT} \text{ PW} = 15 \mu \text{s} I_{T} = 1.13 \text{ A(p)}$	k)	TYP.	2.8	3.0	3.0	3.2	μs		

#### Electrical Characteristics ( $T_1 = 25$ °C, unless otherwise specified) — Standard Triac

Symbol	Test Conditions	Quadrant		QxX8E3 QxX3	QxX8E4 QxX4	Unit
		1 – 11 – 111	MAX.	10	25	mA
I <sub>GT</sub>	$V_D = 12V R_L = 60 \Omega$	IV	TYP.	25	50	mA
V <sub>GT</sub>		1 – 11 – 111	MAX.	1.3	1.3	V
V <sub>GD</sub>	$V_D = V_{DRM} R_L = 3.3 \text{ k}\Omega T_J = 125^{\circ}\text{C}$	ALL	MIN.	0.2	0.2	V
I <sub>H</sub>	$I_{T} = 200 \text{mA}$		MAX.	15	25	mA
dv/dt	V - V Cata Open T - 125°C	400V	MIN.	25	35	V/µs
uv/ut	$V_D = V_{DRM}$ Gate Open $T_J = 125$ °C	600V	IVIIIN.	15	25	ν/μ5
(dv/dt)c	$(di/dt)c = 0.43 \text{ A/ms } T_J = 125^{\circ}\text{C}$		TYP.	1	1	V/µs
t <sub>gt</sub>	$I_{G} = 2 \times I_{GT} \text{ PW} = 15 \mu \text{s} I_{T} = 1.13 \text{ A(p)}$	k)	TYP.	2.5	3.0	μs

Note: x = voltage



#### Static Characteristics (T<sub>j</sub> = 25°C, unless otherwise specified)

Symbol	Test Conditions					Value	Unit
V <sub>TM</sub>	$I_{TM} = 1.13A t_p = 380 \mu s$	MAX.				1.60	V
		MAX.	LxX8Ey / LxXy	T <sub>J</sub> = 25°C	400-600V	2	μΑ
l <sub>DRM</sub>	V - V			T <sub>J</sub> = 110°C	400-600V	0.1	mA
RRM	$V_{DRM} = V_{RRM}$		0 705 10 7	T <sub>J</sub> = 25°C	400-600V	5	μΑ
			QxX8Ey / QxXy	T <sub>J</sub> = 125°C	400-600V	1	mA

#### Thermal Resistances

Symbol	Parameter		Value	Unit
D	lunction to cook (AC)	L/QxX8Ey	60	°C A A /
$R_{\theta(J-C)}$	Junction to case (AC)	L/QxXy	60*	°C/W
R <sub>e(J-A)</sub>	Junction to ambient	L/QxX8Ey	135	°C/W

Note: \* = Mounted on 1 cm<sup>2</sup>1 copper (two-ounce) foil surface

Figure 1: Definition of Quadrants

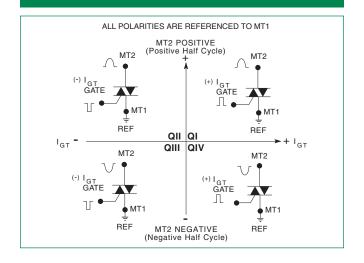


Figure 2: Normalized DC Gate Trigger Current for All Quadrants vs. Junction Temperature

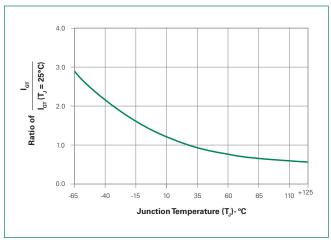


Figure 3: Normalized DC Holding Current vs. Junction Temperature

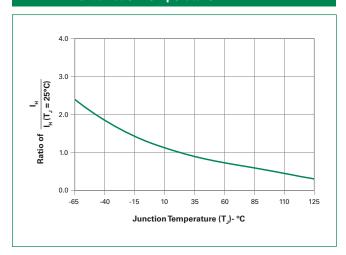


Figure 4: Normalized DC Gate Trigger Voltage for All Quadrants vs. Junction Temperature

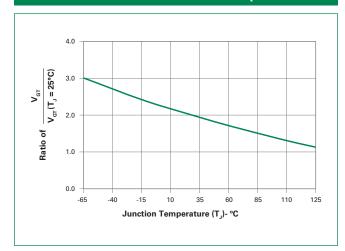


Figure 5: Power Dissipation (Typical) vs. RMS On-State Current

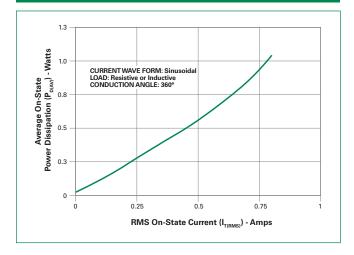


Figure 6: Maximum Allowable Case Temperature vs. On-State Current

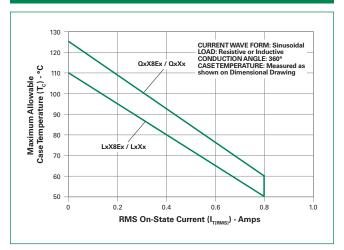


Figure 7: Maximum Allowable Ambient Temperature vs. On-State Current

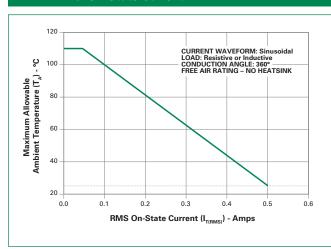
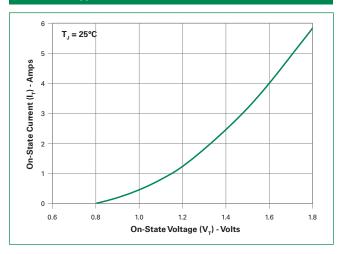
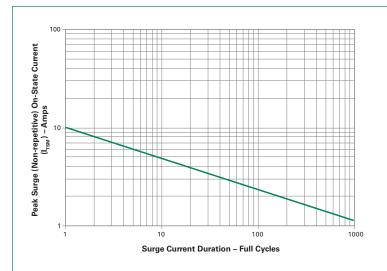


Figure 8: On-State Current vs. On-State Voltage (Typical)





#### Figure 9: Surge Peak On-State Current vs. Number of Cycles



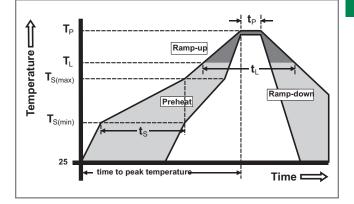
Supply Frequency: 60Hz Sinusoidal Load: Resistive RMS On-State [ $I_{\tiny{T(RMS)}}$ ]: Max Rated Value at Specific Case Temperature

#### Notes:

- 1. Gate control may be lost during and immediately following surge current interval.
- Overload may not be repeated until junction temperature has returned to steady-state rated value.

#### **Soldering Parameters**

Reflow Co	ndition	Pb – Free assembly
	-Temperature Min (T <sub>s(min)</sub> )	150°C
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs
Average ra (T <sub>L</sub> ) to pea	amp up rate (Liquidus Temp) k	5°C/second max
T <sub>S(max)</sub> to T <sub>l</sub>	- Ramp-up Rate	5°C/second max
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C
hellow	-Temperature (t <sub>L</sub> )	60 – 150 seconds
PeakTemp	perature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C
Time with	in 5°C of actual peak ure (t <sub>p</sub> )	20 – 40 seconds
Ramp-dov	vn Rate	5°C/second max
Time 25°C	to peakTemperature (T <sub>P</sub> )	8 minutes Max.
Do not ex	ceed	280°C



# **Teccor® brand Thyristors** 0.8 Amp Sensitive & Standard Triacs



#### **Physical Specifications**

Terminal Finish	100% Matte Tin-plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0
Lead Material	Copper Alloy

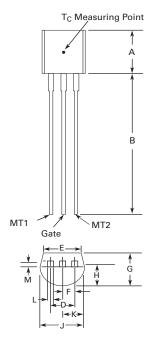
#### **Design Considerations**

Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

#### **Environmental Specifications**

Test	Specifications and Conditions
AC Blocking	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours
Temperature Cycling	MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time
Temperature/ Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity
High Temp Storage	MIL-STD-750, M-1031, 1008 hours; 150°C
Low-Temp Storage	1008 hours; -40°C
Thermal Shock	MIL-STD-750, M-1056 10 cycles; 0°C to 100°C; 5-min dwell- time at each temperature; 10 sec (max) transfer time between temperature
Autoclave	EIA / JEDEC, JESD22-A102 168 hours (121°C at 2 ATMs) and 100% R/H
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

#### **Dimensions — TO-92 (E Package)**

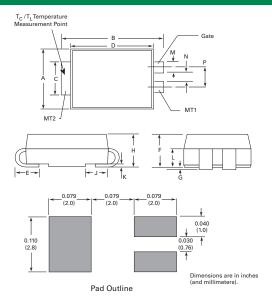


Dimension	Inches		Millimeters		
Difficusion	Min	Max	Min	Max	
А	0.176	0.196	4.47	4.98	
В	0.500		12.70		
D	0.095	0.105	2.41	2.67	
Е	0.150		3.81		
F	0.046	0.054	1.16	1.37	
G	0.135	0.145	3.43	3.68	
Н	0.088	0.096	2.23	2.44	
J	0.176	0.186	4.47	4.73	
K	0.088	0.096	2.23	2.44	
L	0.013	0.019	0.33	0.48	
M	0.013	0.017	0.33	0.43	

All leads insulated from case. Case is electrically nonconductive.



#### **Dimensions — Compak (C Package)**



Dimension	Inc	hes	Millin	neters
Dimension	Min	Max	Min	Max
А	0.130	0.156	3.30	3.95
В	0.201	0.220	5.10	5.60
С	0.077	0.087	1.95	2.20
D	0.159	0.181	4.05	4.60
Е	0.030	0.063	0.75	1.60
F	0.075	0.096	1.90	2.45
G	0.002	0.008	0.05	0.20
Н	0.077	0.104	1.95	2.65
J	0.043	0.053	1.09	1.35
K	0.006	0.016	0.15	0.41
L	0.030	0.055	0.76	1.40
М	0.022	0.028	0.56	0.71
N	0.027	0.033	0.69	0.84
Р	0.052	0.058	1.32	1.47

#### **Product Selector**

Part Number	Voltage		Gate Sensitivity Quadrants		_	D 1
	400V	600V	1 – 11 – 111	IV	Туре	Package
LxX8E3	X	X	3 mA	3 mA	Sensitive Triac	TO-92
LxX3	X	X	3 mA	3 mA	Sensitive Triac	Compak
LxX8E5	X	X	5 mA	5 mA	Sensitive Triac	TO-92
LxX5	X	X	5 mA	5 mA	Sensitive Triac	Compak
LxX8E6	X	X	5 mA	10 mA	Sensitive Triac	TO-92
LxX8E8	X	X	10 mA	20 mA	Sensitive Triac	TO-92
QxX8E3	X	X	10 mA		Standard Triac	TO-92
QxX3	X	X	10 mA		Standard Triac	Compak
QxX8E4	X	X	25 mA		Standard Triac	TO-92
QxX4	X	Х	25 mA		Standard Triac	Compak

Note: x = voltage

#### **Packing Options**

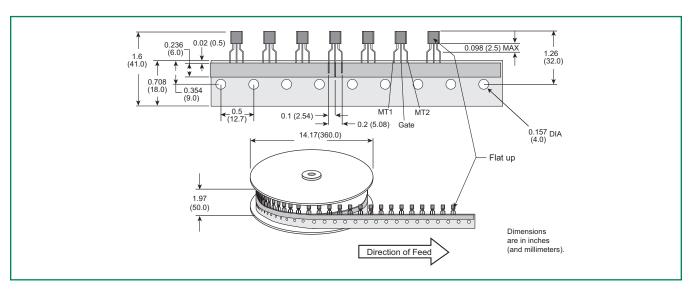
Part Number	Marking	Weight	Packing Mode	Base Quantity
L/QxX8Ey	L/QxX8Ey	0.188 g	Bulk	2000
L/QxX8EyRP	L/QxX8Ey	0.188 g	Reel Pack	2000
L/QxX8EyAP	L/QxX8Ey	0.188 g	Ammo Pack	2000
L/QxXyRP	L/QxXy	0.081 g	Embossed Carrier	2500

Note: x = voltage, y = sensitivity



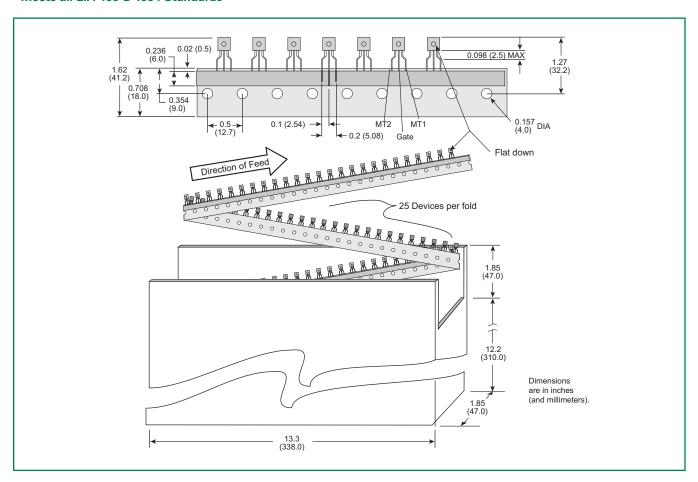
#### TO-92 (3-lead) Reel Pack (RP) Radial Leaded Specifications

#### Meets all EIA-468-B 1994 Standards



#### TO-92 (3-lead) Ammo Pack (AP) Radial Leaded Specifications

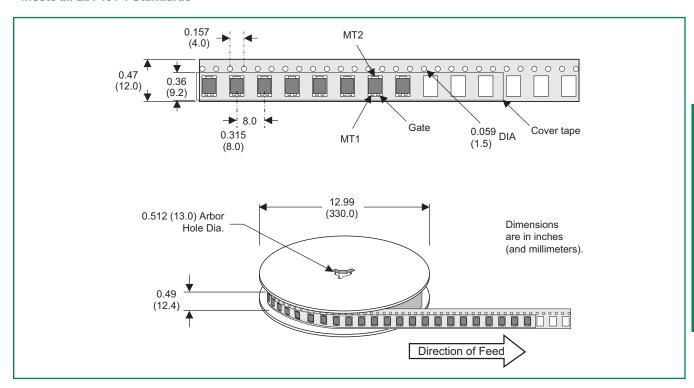
#### Meets all EIA-468-B 1994 Standards



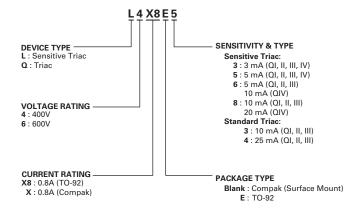


#### **Compak Embossed Carrier Reel Pack (RP) Specifications**

#### Meets all EIA-481-1 Standards



#### **Part Numbering System**



#### **Part Marking System**

TO-92 (E Package) Compak (C Package)





## **Teccor® brand Thyristors**

